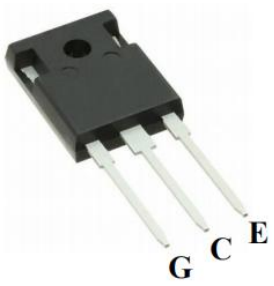
DGW10N65CTL1K

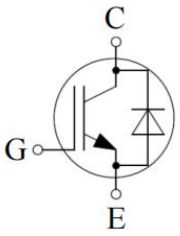
RoHS COMPLIANT



IGBT Discrete

V_{CE}	650	V
I_C	10	A
$V_{CE(SAT)}$ I_C=10A	1.65	V

Circuit



Applications

- Inverter for motor drive
- Air conditioning
- Uninterruptible power supply

Features

- High speed smooth switching device for hard & soft switching
- Maximum junction temperature 175℃
- Positive temperature coefficient
- High short circuit capability(5us)
- High ruggedness, temperature stable

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	650	V
DC Collector Current, limited by T_{jmax} T_C= 25°C T_C= 100°C	I_C	20 10	A
Diode Forward Current, limited by T_{jmax} T_C= 25°C T_C= 100°C	I_F	20 10	A
Continuous Gate-Emitter Voltage	V_{GE}	±20	V
Transient Gate-Emitter Voltage (tp≤10μs,D<0.010)	V_{GE}	±30	V
Turn off Safe Operating Area V_{CE}≤ 650V, T_j≤ 150°C		30	A
Pulsed Collector Current, V_{GE}=15V, tp limited by T_{jmax}	I_{CM}	30	A
Diode Pulsed Current, tp limited by T_{jmax}	I_{Fpuls}	30	A
Short Circuit Withstand Time, V_{GE}= 15V, V_{CC}=400V, V_{CEM}≤650V	T_{sc}	5	μs
Power Dissipation , Tj=175°C, Tc=25°C	P_{tot}	115	W

Operating Junction Temperature	T_j	-40...+175	°C
Storage Temperature	T_s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

Electrical Characteristics of the IGBT（T_j= 25℃unless otherwise specified）:

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Collector-Emitter Breakdown Voltage	BV_{CES}	V_{GE}=0V, I_C=1mA	650		-	V
Gate Threshold Voltage	$V_{GE(th)}$	V_{GE}=V_{CE}, I_C=250μA	4.0	5.5	6.5	V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	V_{GE}=15V, I_C=10A T_j=25°C, T_j=125°C T_j=150°C		1.65 1.80 1.85	2.15	V
Zero Gate Voltage Collector Current	I_{CES}	V_{CE}=650V, V_{GE}=0V T_j= 25°C, T_j=150°C			0.25 5	mA
Gate-Emitter Leakage Current	I_{GES}	V_{CE}= 0V, V_{GE}= ± 20V			±200	nA

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Input Capacitance	C_{ies}	V_{CE}= 25V, V_{GE}= 0V, f = 1MHz	-	0.56	-	nF
Reverse Transfer Capacitance	C_{res}		-	0.01	-	
Gate Charge	Q_G	V_{CC}=400V,I_C=10A, V_{GE}=15V	-	0.06	-	uC

Electrical Characteristics of the Diode（T_j= 25℃unless otherwise specified）:

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Diode Forward Voltage	V_F	I_F= 10A T_j= 25°C T_j= 125°C T_j= 150°C		1.50 1.40 1.35	2.00	V

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T_j= 25℃						
Turn-on Delay Time	$t_{d(on)}$	T_j=25°C V_{CC}= 400V, I_C=10A, V_{GE}=-5V~15V, Rg=10Ω	-	7	-	ns
Rise Time	t_r		-	17	-	ns
Turn-on Energy	E_{on}		-	0.19	-	mJ
Turn-off Delay Time	$t_{d(off)}$		-	23	-	ns
Fall Time	t_f		-	106	-	ns
Turn-off Energy	E_{off}		-	0.17	-	mJ
Dynamic , at T_j= 125℃						
Turn-on Delay Time	$t_{d(on)}$	T_j=125°C V_{CC}= 400V, I_C=10A, V_{GE}=-5V~15V, Rg=10Ω	-	6	-	ns
Rise Time	t_r		-	18	-	ns
Turn-on Energy	E_{on}		-	0.21	-	mJ
Turn-off Delay Time	$t_{d(off)}$		-	28	-	ns
Fall Time	t_f		-	161	-	ns
Turn-off Energy	E_{off}		-	0.25	-	mJ
Dynamic , at T_j= 150℃						
Turn-on Delay Time	$t_{d(on)}$	T_j=150°C V_{CC}= 400V, I_C=10A, V_{GE}=-5V~15V, Rg=10Ω	-	6	-	ns
Rise Time	t_r		-	18	-	ns
Turn-on Energy	E_{on}		-	0.23	-	mJ
Turn-off Delay Time	$t_{d(off)}$		-	31	-	ns
Fall Time	t_f		-	189	-	ns
Turn-off Energy	E_{off}		-	0.30	-	mJ

Electrical Characteristics of the DIODE

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T_j= 25℃						
Reverse Recovery Current	I_{rr}	I_F=10A, V_R=400V, -di/dt= 320A/μs,	-	9	-	A
Diode reverse recovery time	trr		-	81	-	ns
Reverse Recovery Charge	Q_{rr}		-	0.33	-	uC
Reverse Recovery Energy	Erec		-	0.06	-	mJ
Dynamic , at Tj= 125℃						
Reverse Recovery Current	I_{rr}	I_F=10A, V_R=400V, -di/dt= 320A/μs,	-	11	-	A
Diode reverse recovery time	trr		-	99	-	ns
Reverse Recovery Charge	Q_{rr}		-	0.52	-	uC
Reverse Recovery Energy	Erec		-	0.14	-	mJ
Dynamic , at Tj= 150℃						
Reverse Recovery Current	I_{rr}	I_F=10A, V_R=400V, -di/dt= 320A/μs,	-	12	-	A
Diode reverse recovery time	trr		-	106	-	ns
Reverse Recovery Charge	Q_{rr}		-	0.77	-	uC
Reverse Recovery Energy	Erec		-	0.17	-	mJ

Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT Thermal Resistance, Junction - Case	R_{th}(j-c)	1.3	K/W
Diode Thermal Resistance, Junction - Case	R_{th}(j-c)	1.5	K/W
Thermal Resistance, Junction - Ambient	R_{th}(j-a)	40	K/W

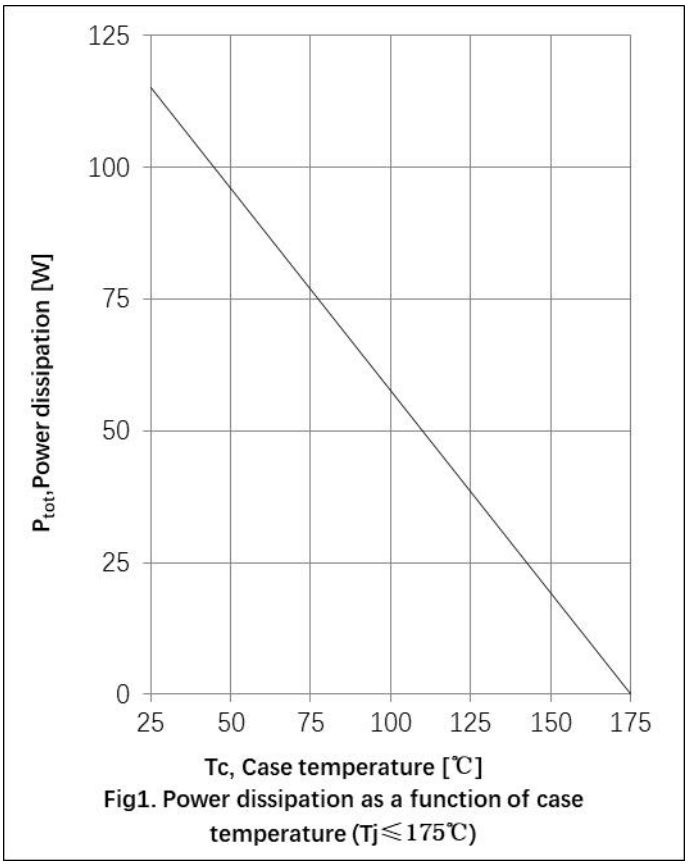


Fig1. Power dissipation as a function of case temperature (Tj≤175℃)

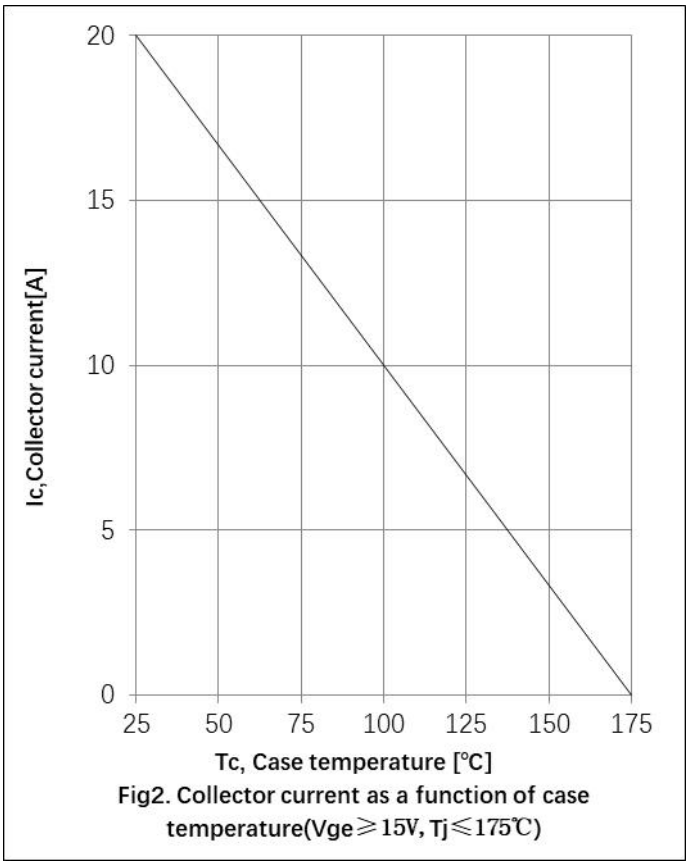


Fig2. Collector current as a function of case temperature(Vge≥15V, Tj≤175℃)

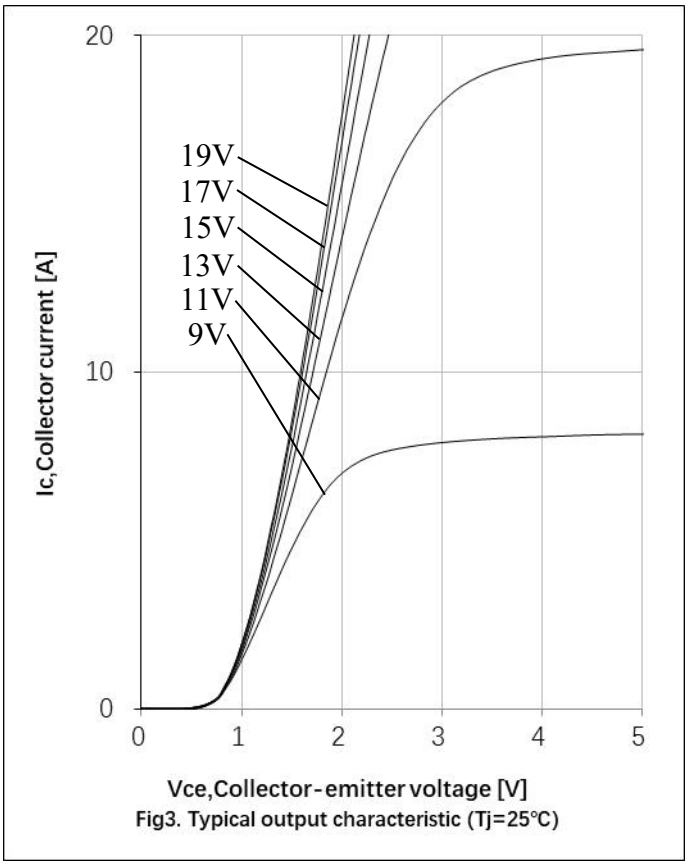


Fig3. Typical output characteristic (Tj=25℃)

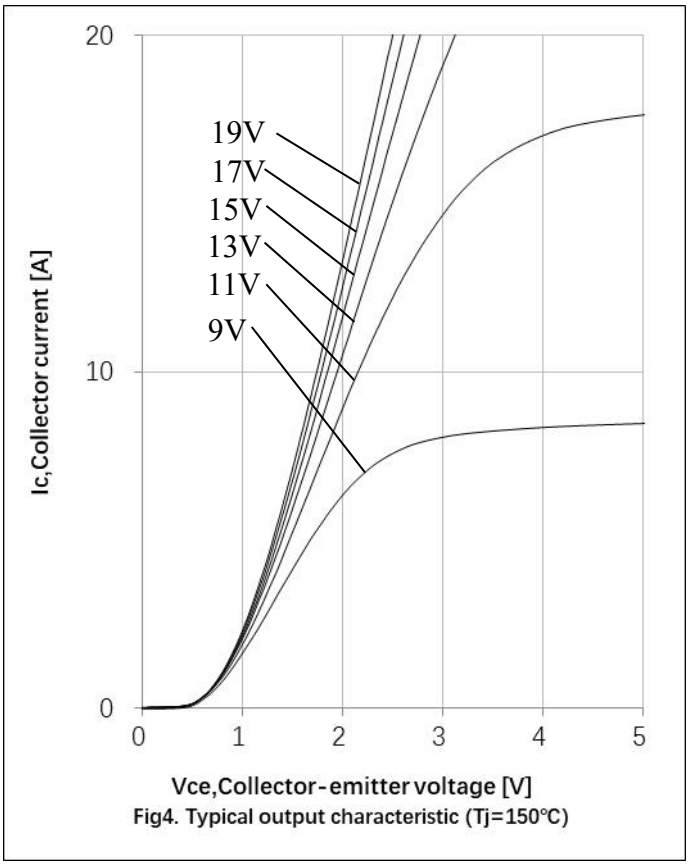


Fig4. Typical output characteristic (Tj=150℃)

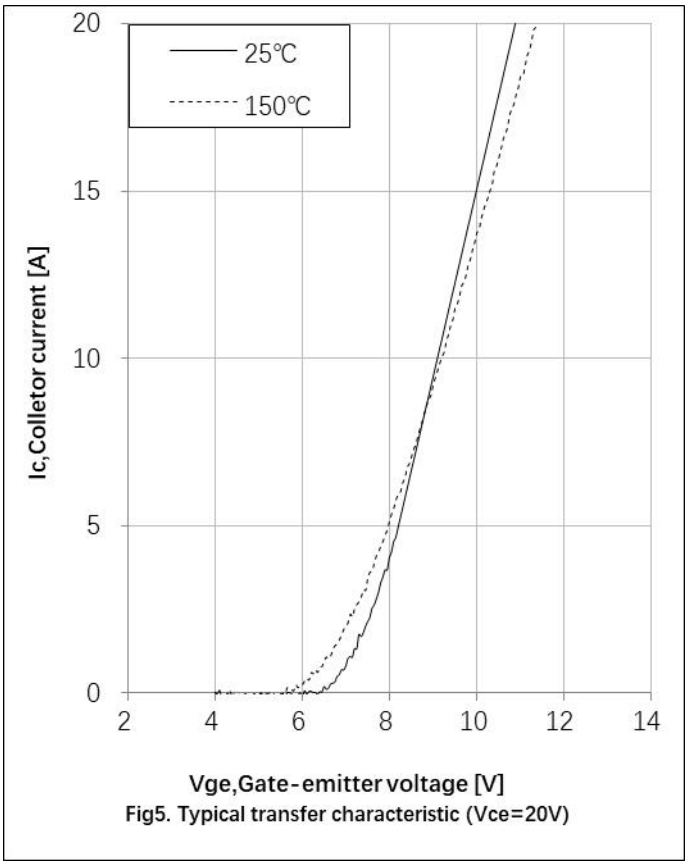


Fig5. Typical transfer characteristic (Vce=20V)

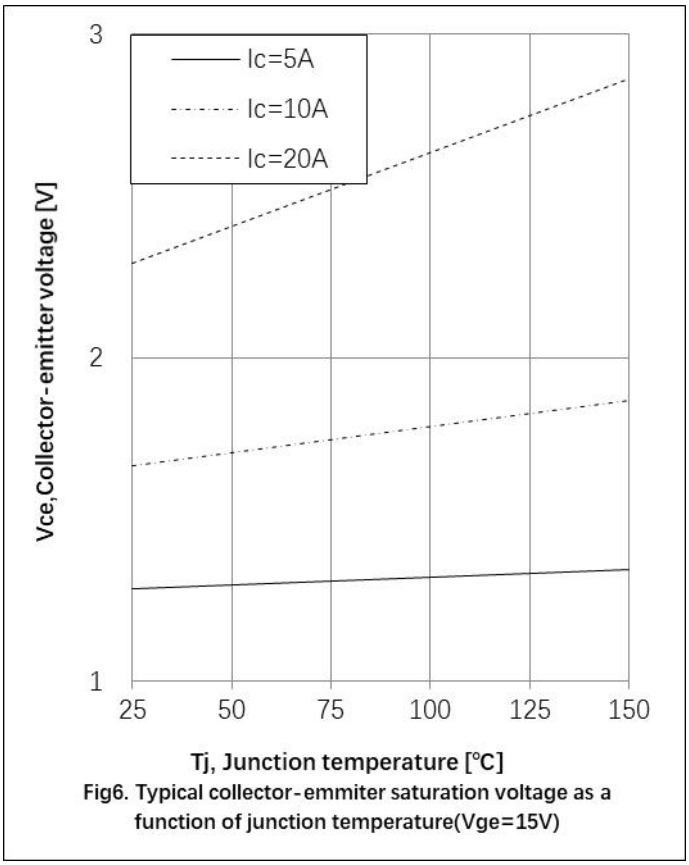


Fig6. Typical collector-emmiter saturation voltage as a function of junction temperature(Vge=15V)

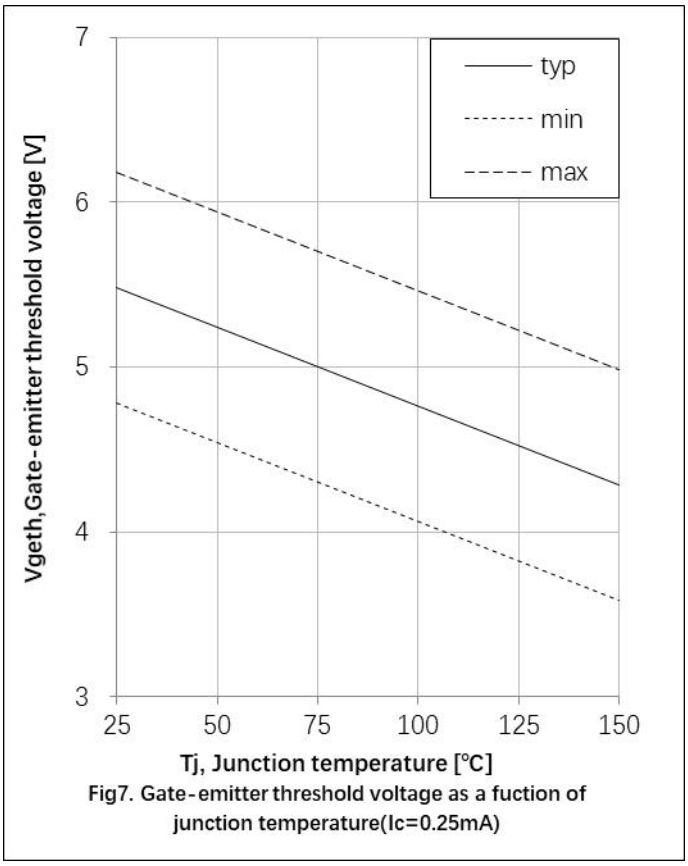


Fig7. Gate-emitter threshold voltage as a fuction of junction temperature(Ic=0.25mA)

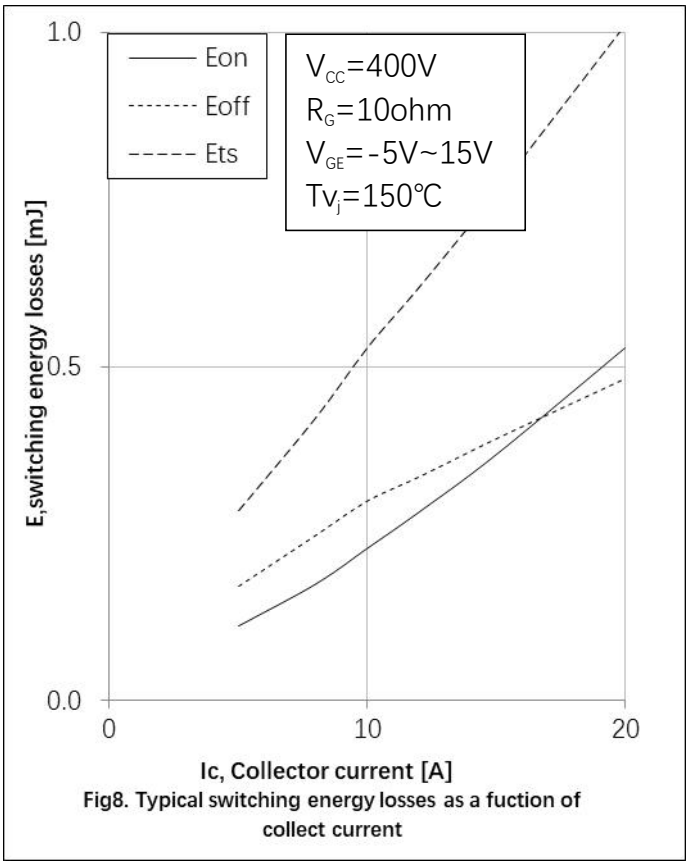


Fig8. Typical switching energy losses as a fuction of collect current

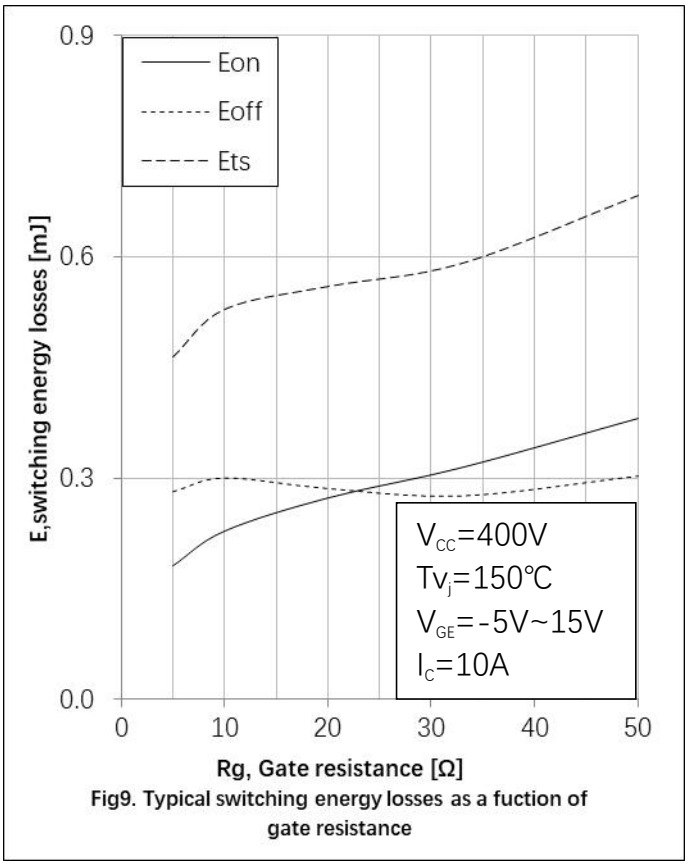


Fig9. Typical switching energy losses as a fuction of gate resistance

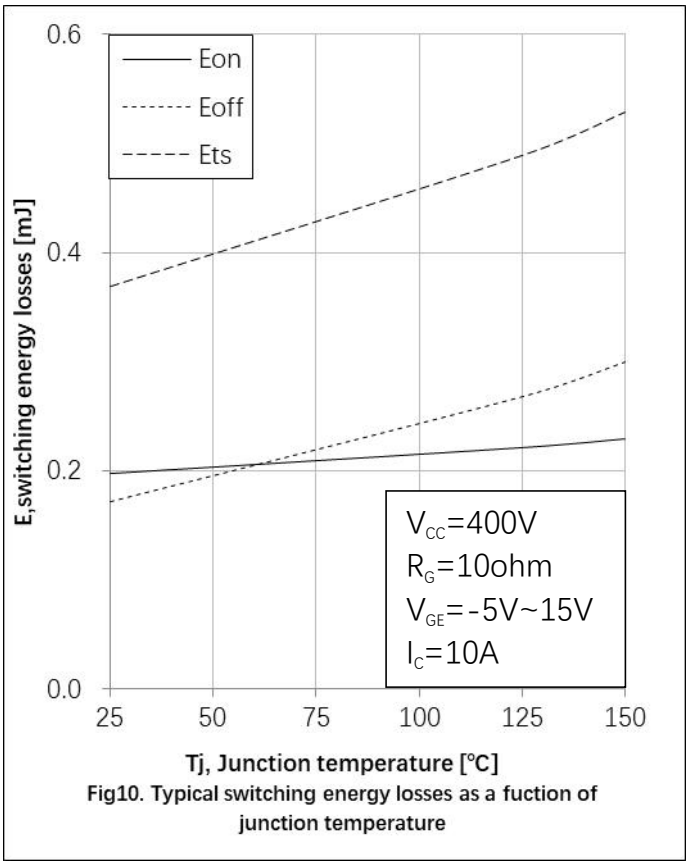


Fig10. Typical switching energy losses as a fuction of junction temperature

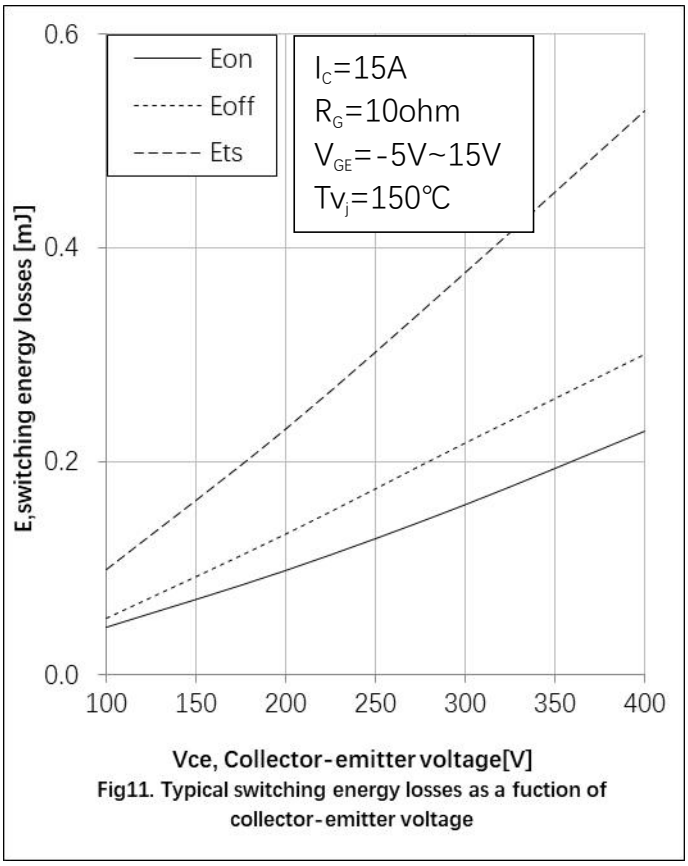


Fig11. Typical switching energy losses as a fuction of collector-emitter voltage

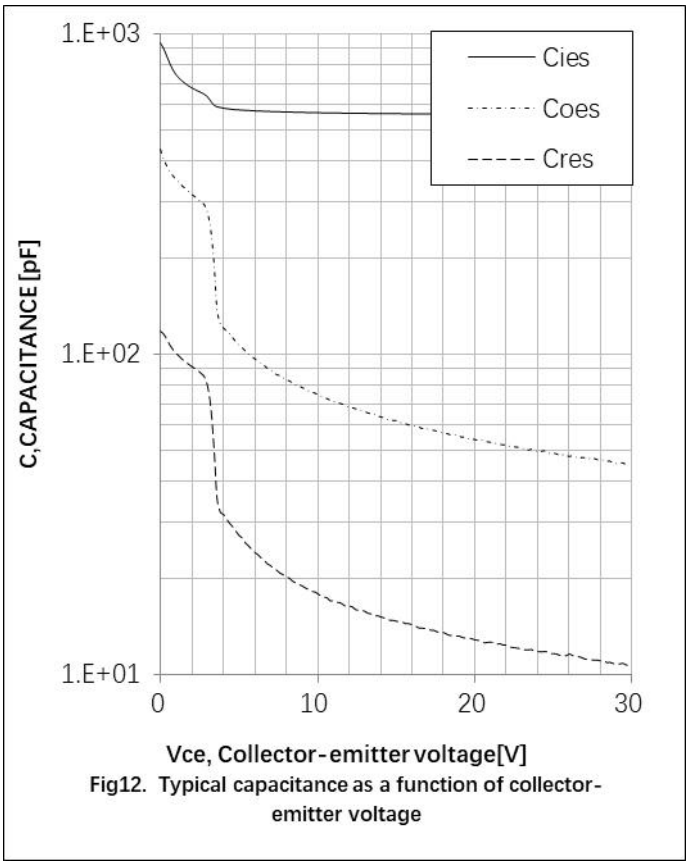


Fig12. Typical capacitance as a function of collector-emitter voltage

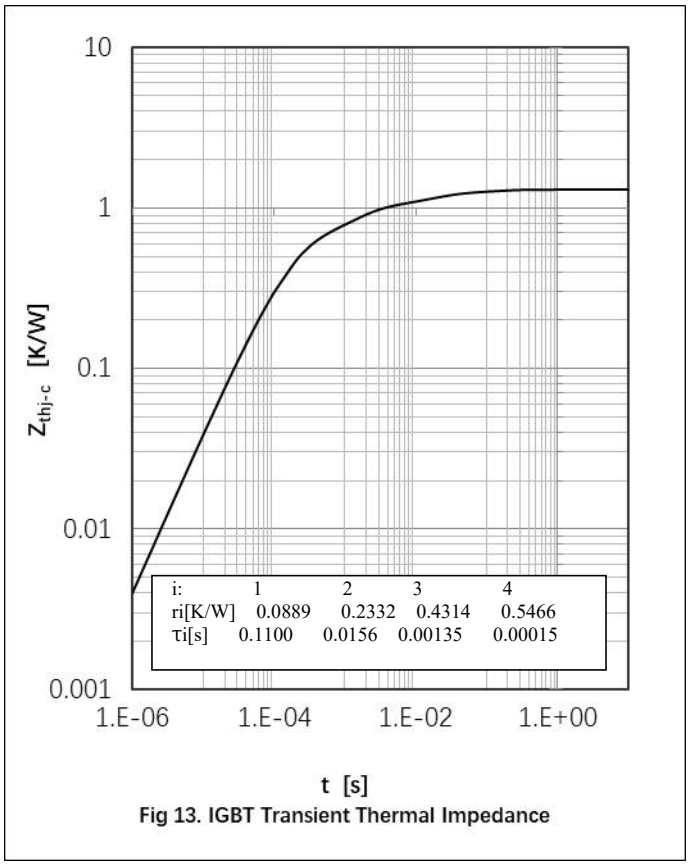


Fig 13. IGBT Transient Thermal Impedance

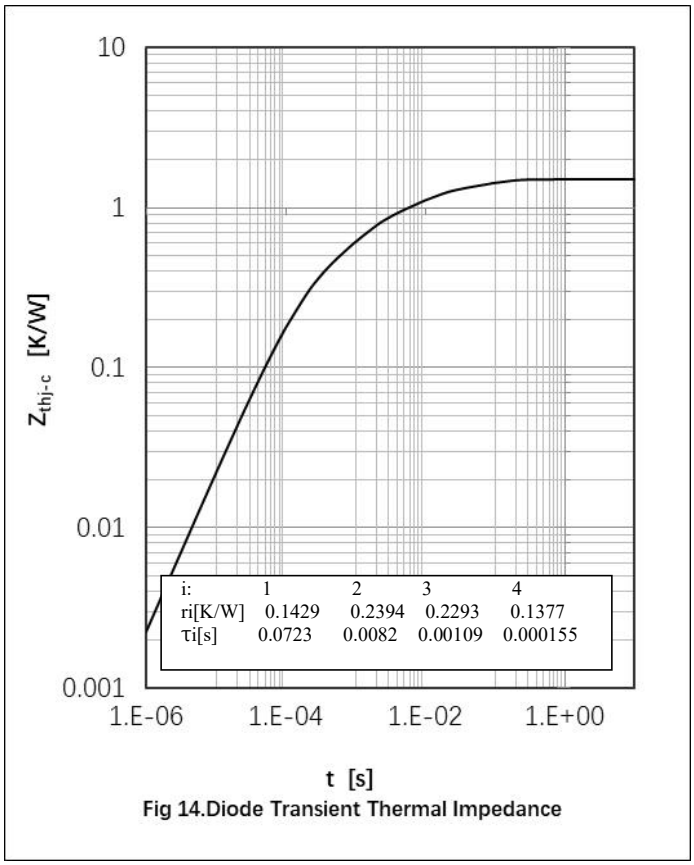


Fig 14.Diode Transient Thermal Impedance

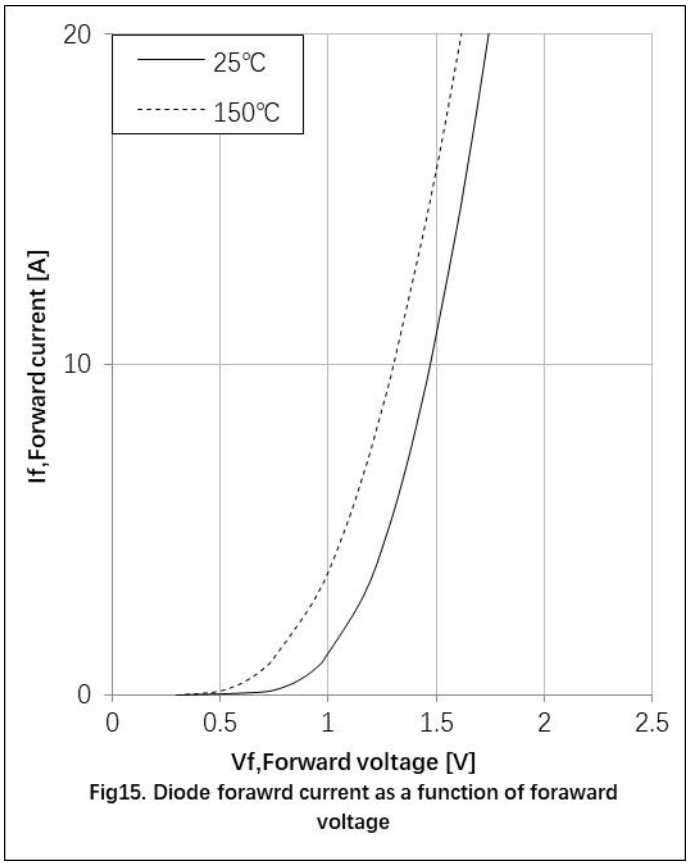


Fig15. Diode forawrd current as a function of foraward voltage

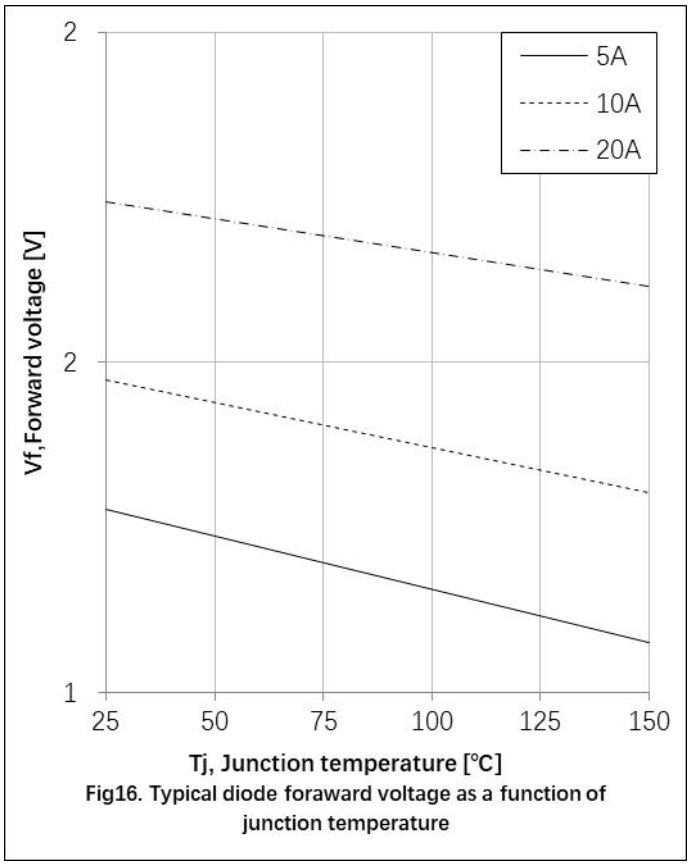
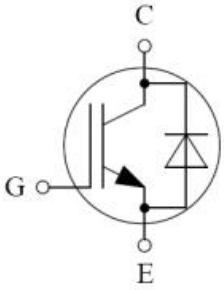


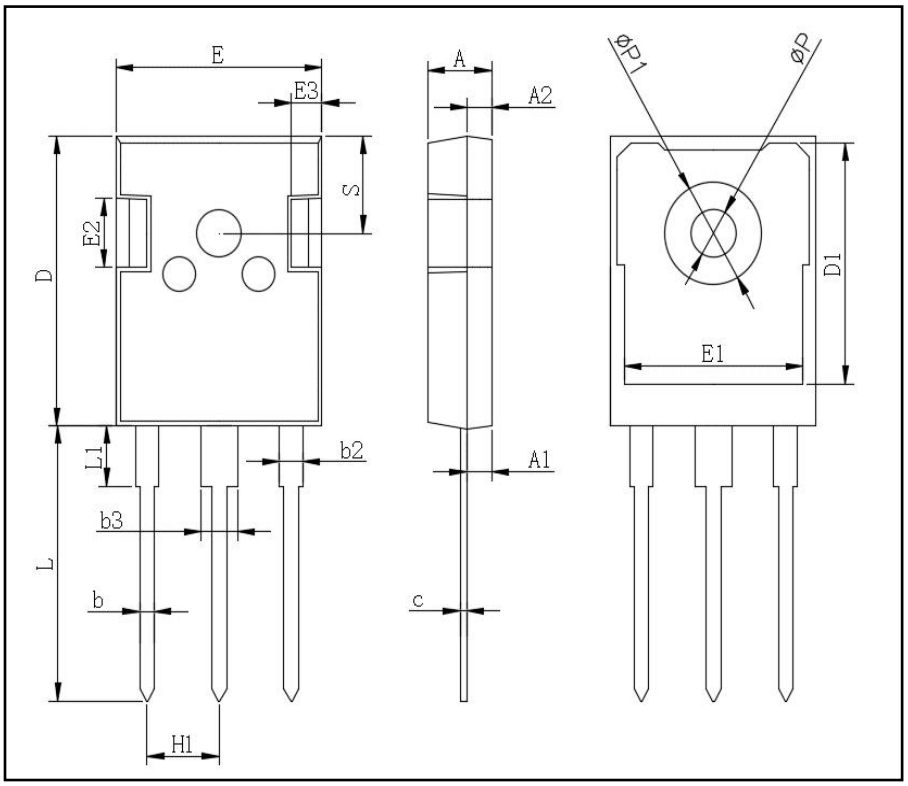
Fig16. Typical diode foraward voltage as a function of junction temperature

Circuit Diagram



Package Outline Information

CASE: TO 247



TO-247AB		
Dim	Min	Max
A	4.80	5.20
A1	2.21	2.61
A2	1.85	2.15
b	1.0	1.4
b2	1.91	2.21
C	0.5	0.7
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.0	13.6
E2	4.80	5.20
E3	2.30	2.70
L	19.62	20.22
L1	-	4.30
ΦP	3.40	3.80
ΦP1	-	7.30
S	6.15TYP	
H1	5.44TYP	
b3	2.80	3.20

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